

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

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HZ0603B112R-10

UNCONTROLLED

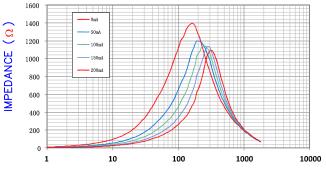
PHYSICAL DIMENSIONS:

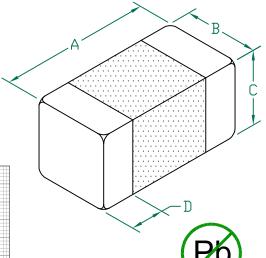
A 1.60 [.063] ± 0.15 [.006] 0.80 [.031] ± 0.15 [.006]

C 0.80 [.031] ± 0.15 [.006]

D 0.36 [.014] ± 0.15 [.006]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS





ELECTRICAL CHARACTERISTICS:									
Z @ 100MHz (<u>Ω</u>)		DCR $\left(\begin{array}{c}\Omega\end{array} ight)$	Rated Current						
Nominal	1100								
Minimum	825								
Maximum	1375	0.80	200 mA						

NOTES: UNLESS OTHERWISE SPECIFIED

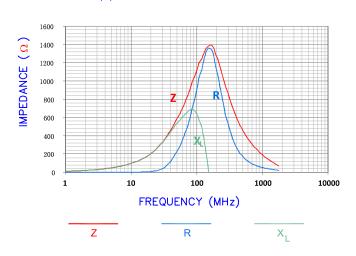
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

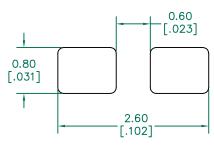
LAND PATTERNS FOR REFLOW SOLDERING

RECOMMENDED SOLDERING CONDITIONS

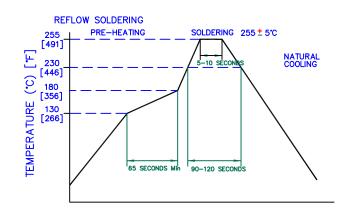
FREQUENCY (MHz)

|Z| , R, AND X vs. FREQUENCY





(For wave soldering, add 0.762 (.030) to this dimension)



2/95/EC	

DIMENSIONS ARE IN mm [INCHES]. This print is the property of Laird											
					Tech and is loaned in confidence subject to return upon request with the understanding that no copies shall be made without the written consent of Laird Tech. A rights to design or invention are	and e	L	a	ird_		
	D	ADD OPERATING TEMPERATURE	W CURVE 08/05/13		reserved. PROJECT/PART NUMBER:	-1	REV	PART TY	PE:	DRAWN BY:	
		ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE			HZ0603B112R-10)	D	co-	-FIRE	ТМВ	
	С	UPDATE CURVES									
	B UPDATE COMPANY LOGO ADD ROHS C		02/26/08	JRK	UP 07/03/07		ALE: _		SHEET:	SHEET:	
	Α	A ORIGINAL DRAFT		TMB					2	of 2	
	REV	DESCRIPTION	DATE	INT				_	_	ŭ. <u>-</u>	

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 6309